



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Seita et al.

U.S.S.N.:

10/696,552

Art Unit:

1753

FILED:

October 29, 2003

Examiner:

Not Yet Assigned

FOR:

FORMALDEHYDE-FREE ELECTROLESS COPPER PLATING PROCESS

AND SOLUTION FOR USE IN THE PROCESS

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## PRELIMINARY AMENDMENT

Please amend the application as follows.

A listing of pending claims begins on page 2 of this paper.

Remarks begin on page 5 of this paper.

08/17/2004 BSAYASI1 00000071 10696552

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